TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74VHC10F, TC74VHC10FT

Triple 3-Input NAND Gate

The TC74VHC10 is an advanced high speed CMOS 3-INPUT NAND GATE fabricated with silicon gate $\rm C^2MOS$ technology.

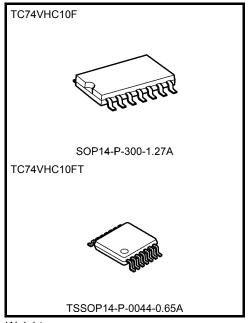
It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

The internal circuit is composed of 3 stages including buffer output, which provide high noise immunity and stable output.

An input protection circuit ensures that 0 to 5.5~V can be applied to the input pins without regard to the supply voltage. This device can be used to interface 5~V to 3~V systems and two supply systems such as battery back up. This circuit prevents device destruction due to mismatched supply and input voltages.

Features

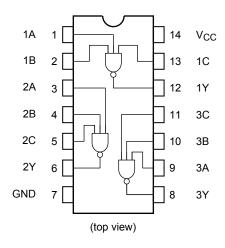
- High speed: $t_{pd} = 3.9 \text{ ns (typ.)}$ at $V_{CC} = 5 \text{ V}$
- Low power dissipation: $I_{CC} = 2 \mu A \text{ (max)}$ at $T_{a} = 25 \text{°C}$
- High noise immunity: $V_{NIH} = V_{NIL} = 28\% V_{CC}$ (min)
- Power down protection is provided on all inputs.
- Balanced propagation delays: $t_{pLH} \simeq t_{pHL}$
- Wide operating voltage range: V_{CC} (opr) = 2 to 5.5 V
- Pin and function compatible with 74ALS10



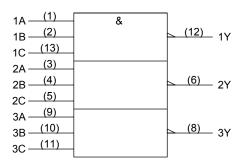
Weight

SOP14-P-300-1.27A : 0.18 g (typ.) TSSOP14-P-0044-0.65A : 0.06 g (typ.)

Pin Assignment



IEC Logic Symbol



Truth Table

| Α | В | С | Y | | |
|---|---|---|---|--|--|
| L | Х | Х | Н | | |
| Х | L | Х | Н | | |
| Х | Х | L | Н | | |
| Н | Н | Н | Ĺ | | |

X: Don't care

Absolute Maximum Ratings (Note)

| Characteristics | Symbol | Rating | Unit |
|------------------------------------|------------------|-------------------------------|------|
| Supply voltage range | V _{CC} | -0.5 to 7.0 | V |
| DC input voltage | V _{IN} | -0.5 to 7.0 | V |
| DC output voltage | Vout | -0.5 to V _{CC} + 0.5 | V |
| Input diode current | lık | -20 | mA |
| Output diode current | lok | ±20 | mA |
| DC output current | lout | ±25 | mA |
| DC V _{CC} /ground current | Icc | ±50 | mA |
| Power dissipation | PD | 180 | mW |
| Storage temperature | T _{stg} | −65 to 150 | °C |

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).



Operating Ranges (Note)

| Characteristics | Symbol | Rating | Unit | |
|---------------------------|------------------|--|--------|--|
| Supply voltage | V_{CC} | 2.0 to 5.5 | V | |
| Input voltage | V _{IN} | 0 to 5.5 | V | |
| Output voltage | V _{OUT} | 0 to V _{CC} | V | |
| Operating temperature | T _{opr} | −40 to 85 | °C | |
| Input rise and fall time | dt/dv | 0 to 100 (V _{CC} = 3.3 ± 0.3 V) | ns/V | |
| input rise and rail tille | didv | 0 to 20 ($V_{CC} = 5 \pm 0.5 \text{ V}$) | 115/ V | |

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V_{CC} or GND.

Electrical Characteristics

DC Characteristics

| Characteristics Symbol | | Test Condition | | | Ta = 25°C | | | Ta = −40 to 85°C | | Unit |
|---------------------------|-----------------|--|--------------------------|---------------------|-----------------------|------|-----------------------|-----------------------|-----------------------|------|
| | | | | V _{CC} (V) | Min | Тур. | Max | Min | Max | |
| High-level input | | | | 2.0 | 1.50 | _ | _ | 1.50 | _ | |
| voltage | V _{IH} | _ | _ | | V _{CC} × 0.7 | _ | _ | V _{CC} × 0.7 | _ | V |
| Low-level input | | - | | 2.0 | _ | _ | 0.50 | _ | 0.50 | |
| voltage | V _{IL} | | | 3.0 to 5.5 | _ | ı | V _{CC} × 0.3 | _ | V _{CC} × 0.3 | V |
| | | | | 2.0 | 1.9 | 2.0 | _ | 1.9 | _ | |
| | | V _{IN} = V _{IH} or V _{IL} | I _{OH} = -50 μA | 3.0 | 2.9 | 3.0 | _ | 2.9 | _ | |
| High-level output voltage | VoH | | | 4.5 | 4.4 | 4.5 | _ | 4.4 | - | V |
| Ĭ | | | I _{OH} = -4 mA | 3.0 | 2.58 | _ | _ | 2.48 | _ | |
| | | | $I_{OH} = -8 \text{ mA}$ | 4.5 | 3.94 | 1 | _ | 3.80 | 1 | |
| | | | | 2.0 | - | 0.0 | 0.1 | _ | 0.1 | |
| | | | I _{OL} = 50 μA | 3.0 | _ | 0.0 | 0.1 | _ | 0.1 | |
| Low-level output voltage | V _{OL} | V _{IN} = V _{IH} | | 4.5 | _ | 0.0 | 0.1 | _ | 0.1 | V |
| | | | I _{OL} = 4 mA | 3.0 | _ | _ | 0.36 | _ | 0.44 | |
| | | | I_{OL} = 8 mA | 4.5 | _ | - | 0.36 | _ | 0.44 | |
| Input leakage current | I _{IN} | V _{IN} = 5.5 V or GND | | 0 to 5.5 | _ | _ | ±0.1 | _ | ±1.0 | μΑ |
| Quiescent supply current | Icc | V _{IN} = V _{CC} or GND | | 5.5 | _ | _ | 2.0 | _ | 20.0 | μΑ |

3



AC Characteristics (input: $t_r = t_f = 3 \text{ ns}$)

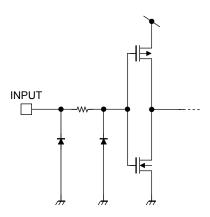
| Characteristics | Symbol | Test Condition | | Ta = 25°C | | | Ta = −40 to 85°C | | Unit | |
|-------------------------------|--------------------------------------|----------------|---------------------|---------------------|-----|------|---------------------|-----|------|------|
| | | | V _{CC} (V) | C _L (pF) | Min | Тур. | Max | Min | Max | |
| Propagation delay time | ^t pLH t _{pHL} | _ | 3.3 ± 0.3 | 15 | _ | 5.7 | 8.4 | 1.0 | 10.0 | - ns |
| | | | | 50 | _ | 8.2 | 11.9 | 1.0 | 13.5 | |
| | | | 5.0 ± 0.5 | 15 | _ | 3.9 | 5.9 | 1.0 | 7.0 | |
| | | | | 50 | _ | 5.4 | 7.9 | 1.0 | 9.0 | |
| Input capacitance | C _{IN} | | _ | | _ | 4 | 10 | _ | 10 | pF |
| Power dissipation capacitance | C _{PD} | | | (Note) | 1 | 17 | - | _ | _ | pF |

Note: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

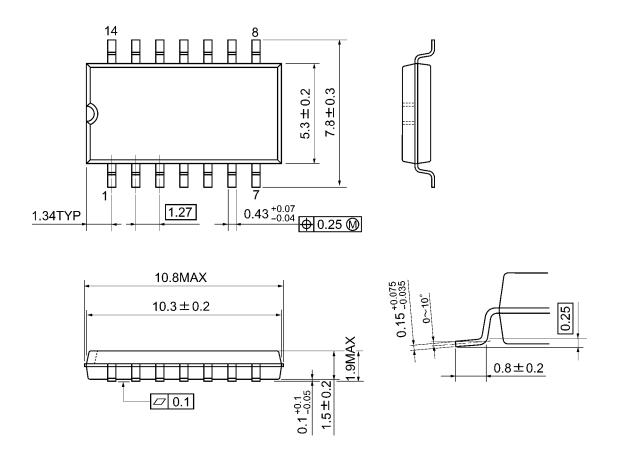
 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/3 \text{ (per gate)}$

Input Equivalent Circuit



Package Dimensions

SOP14-P-300-1.27A Unit: mm



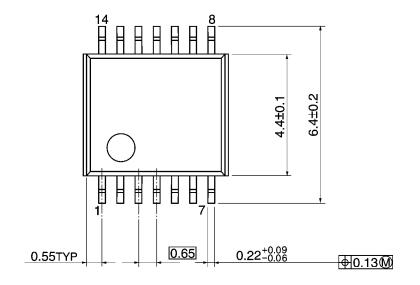
5

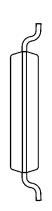
Weight: 0.18 g (typ.)

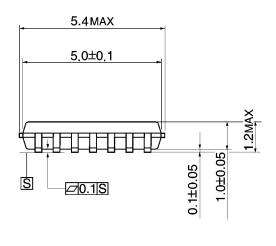
Package Dimensions

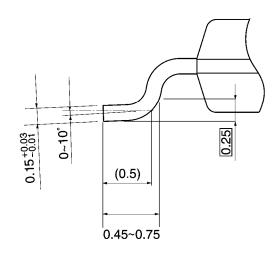
TSSOP14-P-0044-0.65A

Unit: mm









Weight: 0.06 g (typ.)

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